Unit: mm

TOSHIBA PHOTOCOUPLER IRED & PHOTO-IC

TLP715F

Isolated Bus Drivers
High Speed Line Receivers
Microprocessor System Interfaces

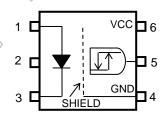
The Toshiba TLP715F consists of an infrared emitting diode and an integrated high-gain, high-speed photodetector. This unit is a 6-pin SDIP. The TLP715F is 50% smaller than the 8-PIN DIP and meets the reinforced insulation class requirements of international safety standards. Therefore the mounting area can be reduced in equipment requiring safety standard certification. The detector has a totem pole output stage to provide both source and sink driving. The detector IC has an internal shield that provides a guaranteed common-mode transient immunity. The TLP715F is buffer logic type. For inverter logic type, the TLP718F is in line-up.

- Buffer logic output (totem pole output)
- Guaranteed performance over temperature: -40 to 100°C
- Power supply voltage: 4.5 to 20 V
- Input current: IFLH = 3 mA (max)
- Switching time (tpLH / tpHL): 250 ns (max)
- Common-mode transient immunity: ±10 kV / μs (min)
- Isolation voltage: 5000 Vrms (min)
- UL-recognized: UL 1577, File No.E67349
- cUL-recognized: CSA Component Acceptance Service No.5A File No.E67349
- VDE-approved : EN 60747-5-5 , EN 62368-1 (Note 1)

Note 1: When a VDE approved type is needed, please designate the **Option(D4)**.

Weight: 0.26 g (typ.)

Pin Configuration (Top View)



1: ANODE

2: N.C.

3: CATHODE

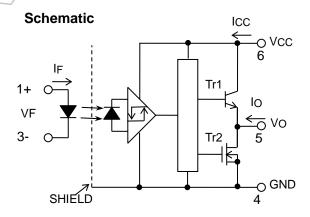
4: GND

5: Vo (Output)

6: VCC

Truth Table

Input	LED	Tr1	Tr2	Output
Н	ON	ON	OFF	Œ
L	OFF	OFF	ON	ZIL.



Note: $0.1 \mu F$ bypass capacitor must be connected between pins 6 and 4.

Start of commercial production 2008-11

Absolute Maximum Ratings (Ta = 25°C)

	CHARACTERISTIC	SYMBOL	RATING	UNIT
	Forward Current (Ta ≤ 83°C)	lF	20	mA
	Forward Current Derating (Ta ≥ 83°C)	ΔI _F /ΔTa	-0.48	mA/°C
	Peak Transient Forward Current (Note 1)	IFPT	1 <	А
LED	Reverse Voltage	VR	5	V
	Diode power dissipation	PD	40	mW
	Diode power dissipation derating (Ta ≥ 83°C)	ΔP _D /°C	-0.95	mW/°C
	Junction Temperature	Tj	125	<i>))</i> ∘c
	Output Current 1 (Ta ≤ 25°C)	I _{O1}	25 / -15	mA
	Output Current 2 (Ta ≤ 100°C)	I _{O2}	13/-13	mA
⁷ OR	Output Voltage	Vo (-0.5 to 20	v <
DETECTOR	Supply Voltage	Vcc	-0.5 to 20	V
DEI	Power dissipation	Pc((//	75	mW
	Power dissipation derating (Ta ≥ 25°C)	ΔPc/°C	-0.75	mW / °C
	Junction Temperature	Tį >	125	ŷ
Oper	ating Temperature Range	Topr	-40 to 100	Ç
Stora	ge Temperature Range	Tstg	-55 to 125	°C
Lead	Solder Temperature (10 s)	Tsol	260	°C
Isolat	tion Voltage (AC,60 s, R.H. ≤ 60 %) (Note 2)	BVs	5000	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: Pulse width PW ≤ 1 µs, 300 pps.

Note 2: Device Considered a two terminal device: pins 1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

Recommended Operating Conditions

CHARACTERISTIC	SYMBOL	MIN	TYP.	MAX	UNIT
Input Current, ON	IF(ON)	4.5	-	10	mA
Input Voltage, OFF	VF(QFF)	0		8.0	٧
Supply Voltage (Note 1)	Усс	4.5	-	20	V
Operating Temperature	Topr	-40	-	100	°C

Note 1: This item denotes operating ranges, not meaning of recommended operating conditions.

Note: Recommended operating conditions are given as a design guideline to obtain expected performance of the device. Additionally, each item is an independent guideline respectively. In developing designs using this product, please confirm specified characteristics shown in this document.

Electrical Characteristics (Unless otherwise specified, Ta =-40 to 100°C, V_{CC} = 4.5 to 20 V)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONDITION		MIN	TYP.	MAX	UNIT	
Input forward voltage	VF	-	I _F = 5 mA ,	Га = 2	25 °C	1.4	1.6	1.7	V
Temperature coefficient of	ΔV _F /ΔTa	-	I _F = 5 mA			-	-2.0	-	mV/°C
Input reverse current	IR	-	V _R = 5 V , T	a = 2	5 °C	-	(-)	10	μΑ
Input capacitance	CT	-	V = 0 V, f =	1 MH	z, Ta = 25 °C	- (45	-	pF
Logic LOW output voltage	Vol	1	IOL = 3.5 m	4, VF	= 0.8 V	(-(//	0.2	0.6	V
La sia LUOLI autout valiana	Voh		I _{OH} = -2.6 m	ıΑ,	Vcc = 4.5 V	2.7	3.5	-	.,
Logic HIGH output voltage	(Note 1)	2	$I_{F}=5 \text{ mA}$ $V_{CC} = 20 \text{ V}$		17.4	19	-	V	
Logic LOW supply current	ICCL	3	VF = 0V				-	3.0	mA
Logic HIGH supply current	Іссн	4	I _F = 5 mA		4	<u> </u>	- <	3.0	⇒ mA
Logic LOW short circuit output current (Note 2)	I _{OSL}	5	V _F = 0 V		$= V_0 = 5.5 \text{ V}$ $= V_0 = 20 \text{ V}$	15 20	80		mA
Logic HIGH short circuit output current (Note2)	losh	6	IF = 5mA, Vo = GND	-1	= 5.5 V = 20 V	-5 -10	-15 -20	<u>-</u>	mA
Input current logic HIGH	IFLH	-	Io = -2.6 m/	, VQ	> 2.4 V		0.4	3	mA
Input voltage logic LOW	VFHL	-	Io = 3.5 mA	, Vo	< 0.6 V	(0,8) -	-	V
Input current hysteresis	I _{HYS}	- 4	V _{CC} = 5 V				0.05	-	mA

Note: All typical values are at Ta = 25 °C, V_{CC} = 5 V.

Note: A ceramic capacitor (0.1 μ F) should be connected from pin 6 to pin 4 to stabilize the operation of the high gain linear amplifier. Failure to provide the bypassing may impair the switching property. The total lead length between capacitor and coupler should not exceed 1 cm.

Note 1: $VOH = V_{CC} - VO[V]$

Note 2: Duration of output short circuit time should not exceed 10 ms.

Isolation Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CONDITION	MIN	TYP.	MAX	UNIT
Capacitance input to output	CS	V _S = 0 V, f = 1 MHz	-	1.0	-	pF
Isolation resistance	→ Rs	R.H. ≤ 60 %, V _S = 500 V	1×10 ¹²	10 ¹⁴	-	Ω
Isolation voltage	BVs	AC, 60 s	5000	-	-	Vrms

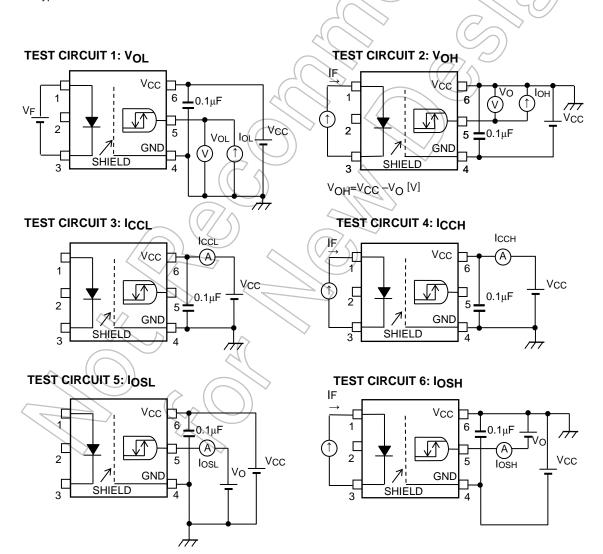
Note: Device Considered a two terminal device: pins 1, 2 and 3 shorted together and pins 4, 5 and 6 shorted together.

Switching Characteristics

(Unless otherwise specified, Ta = -40 to 100°C, VCC = 4.5 to 20 V)

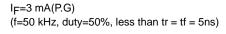
CHARACTERISTIC	SYMBOL	TEST CIRCUIT	CONDITION	MIN	TYP. *	MAX	UNIT
Propagation delay time to logic HIGH output	tрLН		$I_F = 0 \rightarrow 3 \text{ mA}$	30	120	250	ns
Propagation delay time to logic LOW output	t _{pHL}		$I_F = 3 \rightarrow 0 \text{ mA}$	30	120	250	ns
Switching time dispersion between ON and OFF	tpLH-tpHL	7 8	-			220	ns
Rise Time (10 – 90 %)	tr		$ \text{IF} = 0 \rightarrow 3 \text{ mA, VCC} = 5 \text{ V}$		30	-	ns
Fall Time (90 – 10 %)	t _f		$I_F = 3 \rightarrow 0 \text{ mA}, V_{CC} = 5 \text{ V}$	1	30	-	ns
Common-mode transient Immunity at HIGH level output	СМн		V _{CM} = 1000 V _{p-p} , I _F = 5 mA, V _{CC} = 20 V, Ta = 25 °C	10000	- <		V/µs
Common-mode transient Immunity at LOW level output	CML	9	$V_{CM} = 1000 \text{ V}_{p-p}, \text{ I}_F = 0 \text{ mA},$ $V_{CC} = 20 \text{ V}, \text{ Ta} = 25 ^{\circ}\text{C}$	-10000	8		V/µs

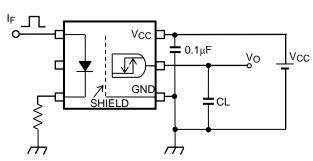
^{*}All typical values are at Ta = 25 °C.

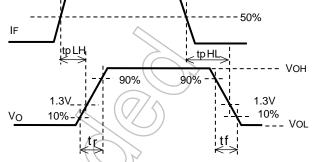


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TEST CIRCUIT 7: Switching Time Test Circuit

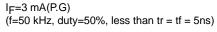


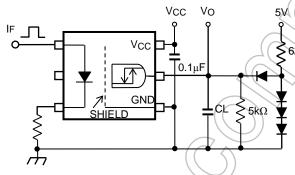


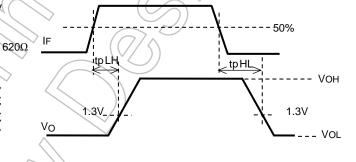


CL: stray capacitance of probe and wiring (to 15 pF)

TEST CIRCUIT 8: Switching Time Test Circuit

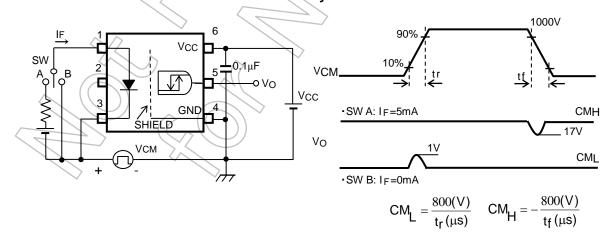






CL: stray capacitance of probe and wiring (to 15 pF)

TEST CIRCUIT 9: Common-Mode Transient Immunity Test Circuit



Note: CMH (CML) is the maximum rate of rise (fall) of the common mode voltage that can be sustained with the output voltage in the high (low) state.

EN 60747-5-5 Option (D4) Specification

Types : TLP715F

Type designations for "option: (D4)", which are tested under EN 60747 requirements.

Ex.: TLP715F (D4-TP,F) D4 : EN 60747 option

TP : Standard tape & reel type

F: [[G]]/RoHS COMPATIBLE (Note 1)

Note: Use TOSHIBA standard type number for safety standard application.

Ex.: TLP715F (D4-TP,F) \rightarrow TLP715F

Note 1: Please contact your Toshiba sales representative for details on environmental information such as the product's RoHS compatibility.

RoHS is the Directive 2011/65/EU of the European Parliament and of the Council of 8 June 2011 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

EN 60747 Isolation Characteristics

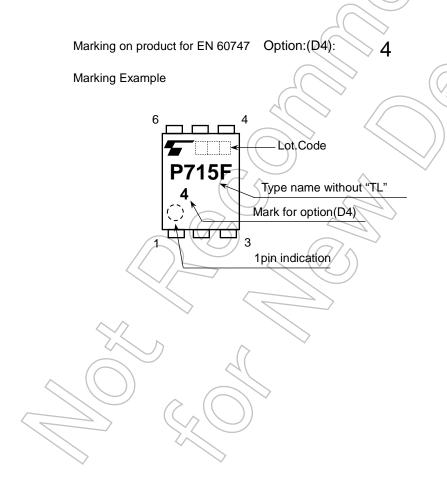
Description		Symbol	Rating	Unit
Application classification for rated mains voltage≤300V _{rms} for rated mains voltage≤600V _{rms}		(Z)	I-IV I-III	_
Climatic classification			40/ 100 / 21	_
Pollution degree		/	2	_
Maximum operating insulation voltage	TLPxxx type	VIORM	890	Vpk
waximum operating insulation voltage	TLPxxxFtype	VIORM	1140	
Input to output test voltage, method A	TLPxxx type		1424	Vpk
Vpr=1.6×V _{IORM} , type and sample test tp=10 s, partial discharge<5pC	TLPxxxFtype	Vpr	1824	
Input to output test voltage, method B	TLPxxx type		1670	
Vpr=1.875×V _{IORM} , 100% production test t _p =1 s, partial discharge<5pC	TLPxxxFtype	Vpr	2140	Vpk
Highest permissible overvoltage (transient overvoltage, t _{pr} = 60 s)		V _{TR}	8000	Vpk
Safety limiting values (max. permissible ratings in case of fault, also refer to thermal deration current (input current IF, $P_{si} = 0$) power (output or total power dissipation) temperature		Isi Psi Ts	300 700 150	mA mW °C
Insulation resistance, input-output VIO =500V VIO =500V VIO =500V	, Ta=100°C	Rsi	≥10 ¹² ≥10 ¹¹ ≥10 ⁹	Ω

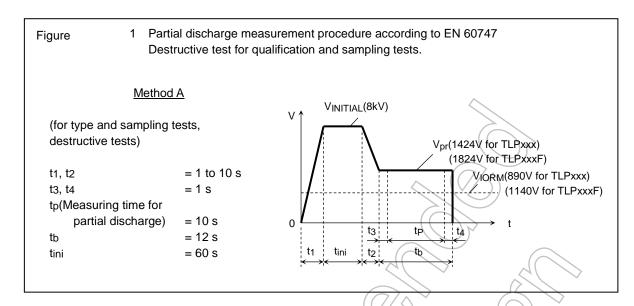
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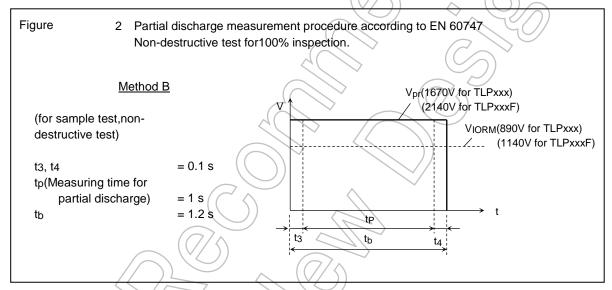
Insulation Related Specifications

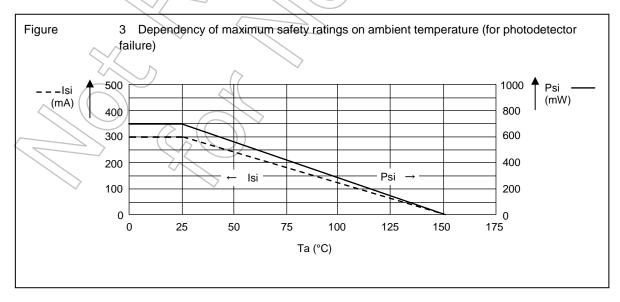
		7.62mm pitch TLPxxx type	10.16mm pitch TLPxxxF type	
Minimum creepage distance	Cr	7.0mm	8.0mm	
Minimum clearance	CI	7.0mm	8.0mm	
Minimum insulation thickness	ti	0.4mm		
Comperative tracking index	CTI	17	5)	

- 1. If a printed circuit is incorporated, the creepage distance and clearance may be reduced below this value. If this is not permissible, the user shall take suitable measures.
- 2. This photocoupler is suitable for 'safe electrical isolation' only within the safety limit data. Maintenance of the safety data shall be ensured by means of protective circuits.









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